

205650US3

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF:

JUNJI YAMADA : GROUP ART UNIT: 2827

SERIAL NO: 09/828,947 :

FILED: APRIL 10, 2001 : EXAMINER: MITCHELL, J.

FOR: POWER SEMICONDUCTOR
MODULE

AMENDMENT AFTER FINAL

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

SIR:

In response to the Official Action mailed July 25, 2002, please amend the above-identified application as follows:

IN THE CLAIMS

1. (Twice Amended) A power semiconductor module, comprising:

an electrode terminal connected with an electric power semiconductor device which is resin sealed inside of a case at one end while having a hole and exposed along a side of an outer surface of the case at the other end;

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an electrode plate for external connection having a hole and arranged to overlie said electrode terminal on an outer surface of the case;

a female screw hole provided on the outer surface of the case so as to correspond to said hole of the electrode terminal; and

a male screw member having screw threads disposed on both ends, penetrating

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